

# LM3704/LM3705 Microprocessor Supervisory Circuits with Power Fail Input, Low Line Output and Manual Reset

Check for Samples: [LM3704](#), [LM3705](#)

## FEATURES

- Standard Reset Threshold voltage: 3.08V
- Custom Reset Threshold voltages: For other voltages between 2.2V and 5.0V in 10mV increments, contact National Semiconductor Corp.
- No external components required
- Manual-Reset input
- $\overline{\text{RESET}}$  (LM3704) or RESET (LM3705) outputs
- Precision supply voltage monitor
- Factory programmable Reset Timeout Delay
- Separate Power Fail comparator
- Available in micro SMD package for minimum footprint

- $\pm 0.5\%$  Reset threshold accuracy at room temperature
- $\pm 2\%$  Reset threshold accuracy over temperature extremes
- Reset assertion down to 1V  $V_{CC}$  ( $\overline{\text{RESET}}$  option only)
- 28  $\mu\text{A}$   $V_{CC}$  supply current

## APPLICATIONS

- Embedded Controllers and Processors
- Intelligent Instruments
- Automotive Systems
- Critical  $\mu\text{P}$  Power Monitoring

## DESCRIPTION

The LM3704/LM3705 series of microprocessor supervisory circuits provide the maximum flexibility for monitoring power supplies and battery controlled functions in systems without backup batteries. The LM3704/LM3705 series are available in MSOP-10 and 9-bump micro SMD packages.

Built-in features include the following:

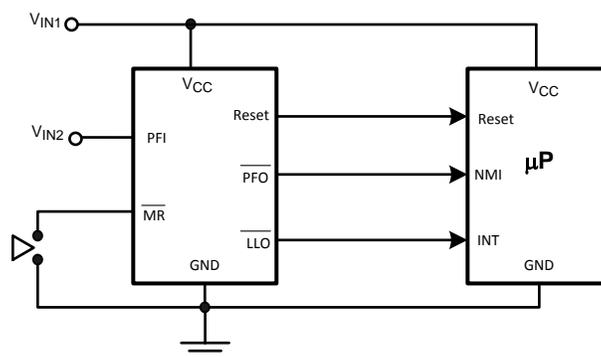
**Reset:** Reset is asserted during power-up, power-down, and brownout conditions.  $\overline{\text{RESET}}$  is guaranteed down to  $V_{CC}$  of 1.0V.

**Manual Reset Input:** An input that asserts reset when pulled low.

**Power-Fail Input:** A 1.225V threshold detector for power fail warning, or to monitor a power supply other than  $V_{CC}$ .

**Low Line Output:** This early power failure warning indicator goes low when the supply voltage drops to a value which is 2% higher than the reset threshold voltage.

## Typical Application



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### Connection Diagram

Figure 1. MSOP-10

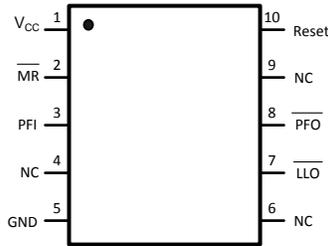
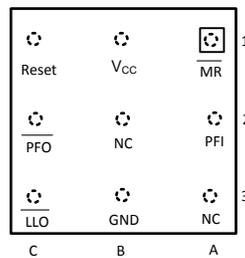


Figure 2. micro SMD 9 Bump Package Top View (looking from the coating side)



### Pin Functions

#### Pin Description

Pin No.		Name	Function
micro SMD	MSOP		
A1	2	$\overline{MR}$	Manual-Reset input. When $\overline{MR}$ is less than $V_{MRT}$ (Manual Reset Threshold) $\overline{RESET}/RESET$ is engaged.
B1	1	$V_{CC}$	Power Supply input.
C1	10	$\overline{RESET}$	Reset Logic Output. Pulses low for $t_{RP}$ (Reset Timeout Period) when triggered, and stays low whenever $V_{CC}$ is below the reset threshold or when $\overline{MR}$ is below $V_{MRT}$ . It remains low for $t_{RP}$ after either $V_{CC}$ rises above the reset threshold, or after $\overline{MR}$ input rises above $V_{MRT}$ (LM3704 only).
		RESET	Reset Logic Output. RESET is the inverse of $\overline{RESET}$ (LM3705 only).
C2	8	$\overline{PFO}$	Power-Fail Logic Output. When PFI is below $V_{PFT}$ , $\overline{PFO}$ goes low; otherwise, $\overline{PFO}$ remains high.
C3	7	$\overline{LLO}$	Low-Line Logic Output. Early Power-Fail warning output. Low when $V_{CC}$ falls below $V_{LLOT}$ (Low-Line Output Threshold). This output can be used to generate an NMI (Non-Maskable Interrupt) to provide an early warning of imminent power-failure.
B3	5	GND	Ground reference for all signals.
A3	4, 6	NC	No Connect.
A2	3	PFI	Power-Fail Comparator Input. When PFI is less than $V_{PFT}$ (Power-Fail Reset Threshold), the $\overline{PFO}$ goes low; otherwise, $\overline{PFO}$ remains high.
B2	9	NC	No Connect. Test input used at factory only. Leave floating.

Block Diagram

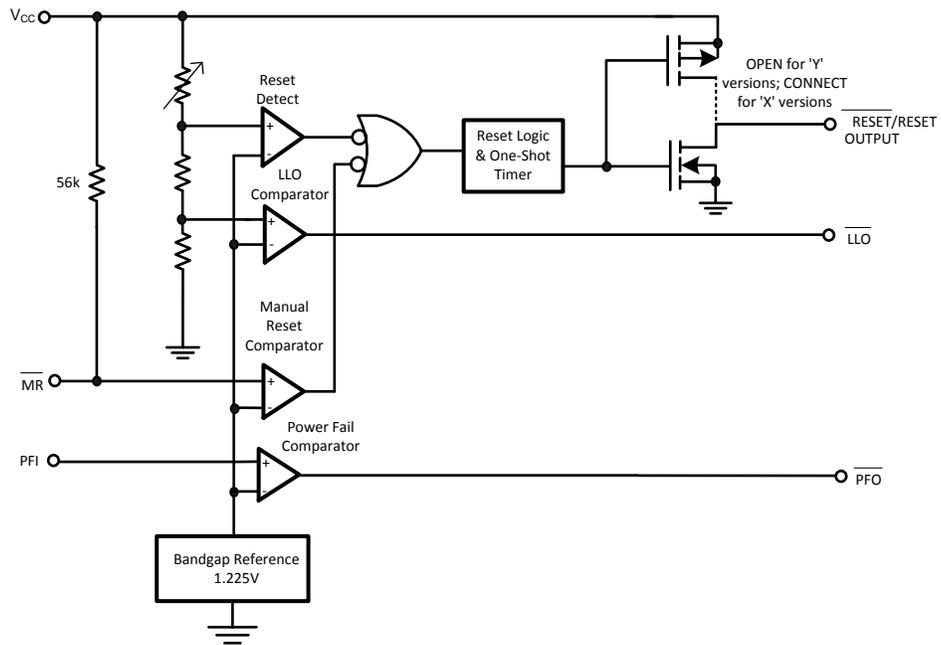


Figure 3. Block Diagram

Table of Functions

Part Number	Active Low Reset	Active High Reset	Output (X = totem-pole) (Y = open-drain)	Reset Timeout Period	Manual Reset	Power Fail Comparator	Low Line Output
LM3704	x		X, Y*	Customized	x	x	x
LM3705		x	X	Customized	x	x	x



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### Absolute Maximum Ratings <sup>(1)</sup>

Supply Voltage ( $V_{CC}$ )	-0.3V to 6.0V
All Other Inputs	-0.3V to $V_{CC} + 0.3V$
ESD Ratings <sup>(2)</sup>	
Human Body Model	1.5kV
Machine Model	150V
Power Dissipation	<sup>(3)</sup>

- (1) **Absolute Maximum Ratings** indicate limits beyond which damage to the device may occur. **Operating Ratings** indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed conditions.
- (2) The Human Body model is a 100 pF capacitor discharged through a 1.5 k $\Omega$  resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin.
- (3) The maximum allowable power dissipation is a function of the maximum junction temperature,  $T_J(\text{MAX})$ , the junction-to-ambient thermal resistance,  $\theta_{J-A}$ , and the ambient temperature,  $T_A$ . The maximum allowable power dissipation at any ambient temperature is calculated using:
- $$P_{(\text{MAX})} = \frac{T_J(\text{MAX}) - T_A}{\theta_{J-A}}$$
- Where the value of  $\theta_{J-A}$  for the MSOP-10 package is 195°C/W in a typical PC board mounting and the micro SMD package is 220°C/W.

### Operating Ratings <sup>(1)</sup>

Temperature Range	$-40^\circ\text{C} \leq T_J \leq 85^\circ\text{C}$
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- (1) **Absolute Maximum Ratings** indicate limits beyond which damage to the device may occur. **Operating Ratings** indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed conditions.

**LM3704/LM3705 Series Electrical Characteristics**

 Limits in the standard typeface are for  $T_J = 25^\circ\text{C}$  and limits in **boldface type** apply over full operating range. Unless otherwise specified:  $V_{CC} = +2.2\text{V}$  to  $5.5\text{V}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>POWER SUPPLY</b>						
$V_{CC}$	Operating Voltage Range: $V_{CC}$	LM3704	<b>1.0</b>		<b>5.5</b>	V
		LM3705	<b>1.2</b>		<b>5.5</b>	
$I_{CC}$	$V_{CC}$ Supply Current	All inputs = $V_{CC}$ ; all outputs floating		28	<b>50</b>	$\mu\text{A}$
<b>RESET THRESHOLD</b>						
$V_{RST}$	Reset Threshold	$V_{CC}$ falling	-0.5 <b>-2</b>	$V_{RST}$	+0.5 <b>+2</b>	%
		$V_{CC}$ falling: $T_A = 0^\circ\text{C}$ to $70^\circ\text{C}$	<b>-1.5</b>		<b>+1.5</b>	
$V_{RSTH}$	Reset Threshold Hysteresis			$0.0032 \cdot V_{RST}$		mV
$t_{RP}$	Reset Timeout Period	Reset Timeout Period = A Reset Timeout Period = B Reset Timeout Period = C Reset Timeout Period = D	<b>1</b> <b>20</b> <b>140</b> <b>1120</b>	1.4 28 200 1600	<b>2</b> <b>40</b> <b>280</b> <b>2240</b>	ms
$t_{RD}$	$V_{CC}$ to Reset Delay	$V_{CC}$ falling at $1\text{mV}/\mu\text{s}$		20		$\mu\text{s}$
<b>RESET (LM3705)</b>						
$V_{OL}$	RESET	$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			<b>0.3</b>	V
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			<b>0.3</b>	
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			<b>0.4</b>	
$V_{OH}$	RESET	$V_{CC} > 1.2\text{V}$ , $I_{SOURCE} = 50\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>			V
		$V_{CC} > 1.8\text{V}$ , $I_{SOURCE} = 150\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>			
		$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>			
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>			
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	<b><math>V_{CC} - 1.5\text{V}</math></b>			
$I_{LKG}$	Output Leakage Current	$V_{RESET} = 5.5\text{V}$			<b>1.0</b>	$\mu\text{A}$
<b>RESET (LM3704)</b>						
$V_{OL}$	$\overline{\text{RESET}}$	$V_{CC} > 1.0\text{V}$ , $I_{SINK} = 50\mu\text{A}$			<b>0.3</b>	V
		$V_{CC} > 1.2\text{V}$ , $I_{SINK} = 100\mu\text{A}$			<b>0.3</b>	
		$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			<b>0.3</b>	
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			<b>0.3</b>	
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			<b>0.4</b>	
$V_{OH}$	$\overline{\text{RESET}}$	$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>			V
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>			
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	<b><math>V_{CC} - 1.5\text{V}</math></b>			
<b>PFI/MR</b>						
$V_{PFT}$	PFI Input Threshold		<b>1.200</b>	1.225	<b>1.250</b>	V
$V_{MRT}$	$\overline{\text{MR}}$ Input Threshold	$\overline{\text{MR}}$ , Low			<b>0.8</b>	V
		$\overline{\text{MR}}$ , High	<b>2.0</b>			
$V_{PFTH}/V_{MRT H}$	PFI/ $\overline{\text{MR}}$ Threshold Hysteresis	PFI/ $\overline{\text{MR}}$ falling: $V_{CC} = V_{RST \text{ MAX}}$ to $5.5\text{V}$		$0.0032 \cdot V_{RST}$		mV
$I_{PFI}$	Input Current (PFI only)		<b>-75</b>		<b>75</b>	nA
$R_{MR}$	$\overline{\text{MR}}$ Pull-up Resistance		<b>35</b>	56	<b>75</b>	k $\Omega$
$t_{MD}$	$\overline{\text{MR}}$ to Reset Delay			12		$\mu\text{s}$
$t_{MR}$	$\overline{\text{MR}}$ Pulse Width		<b>25</b>			$\mu\text{s}$
<b>PFO, LLO</b>						

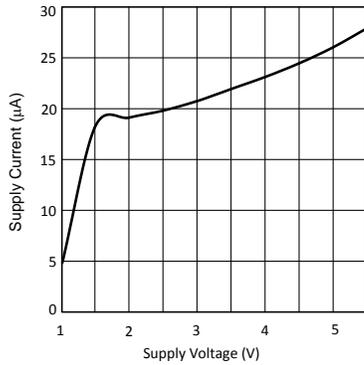
**LM3704/LM3705 Series Electrical Characteristics (continued)**

Limits in the standard typeface are for  $T_J = 25^\circ\text{C}$  and limits in **boldface type** apply over full operating range. Unless otherwise specified:  $V_{CC} = +2.2\text{V}$  to  $5.5\text{V}$ .

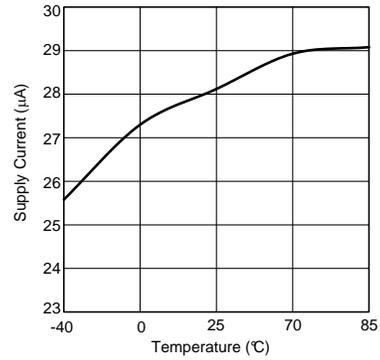
Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{OL}$	$\overline{\text{PFO}}$ , $\overline{\text{LLO}}$ Output Voltage	$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			<b>0.3</b>	V
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			<b>0.3</b>	
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			<b>0.4</b>	
$V_{OH}$		$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	<b><math>0.8 V_{CC}</math></b>			
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	<b><math>0.8 V_{CC}</math></b>			
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	<b><math>V_{CC} - 1.5\text{V}</math></b>			
<b><math>\overline{\text{LLO}}</math> OUTPUT</b>						
$V_{LLOT}$	$\overline{\text{LLO}}$ Output Threshold ( $V_{LLO} - V_{RST}$ , $V_{CC}$ falling)		<b><math>1.01 \cdot V_{RST}</math></b>	$1.02 \cdot V_{RST}$	<b><math>1.03 \cdot V_{RST}</math></b>	V
$V_{LLOTH}$	Low-Line Comparator Hysteresis			$0.0032 \cdot V_{RST}$		mV
$t_{CD}$	Low-Line Comparator Delay	$V_{CC}$ falling at $1\text{mV}/\mu\text{s}$		20		$\mu\text{s}$

Typical Performance Characteristics

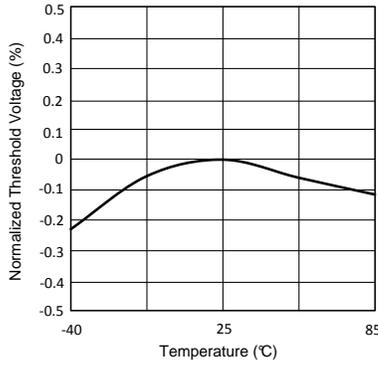
Supply Current vs Supply Voltage



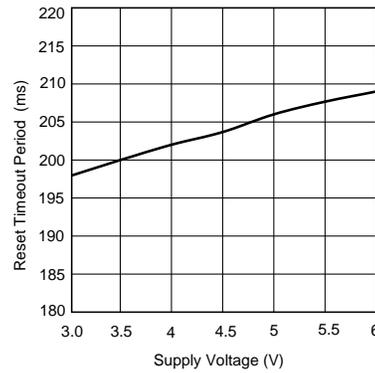
3.3V Supply Current vs Temperature



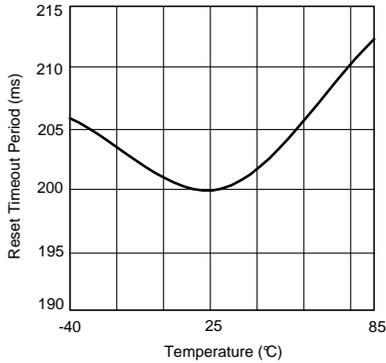
Normalized Reset Threshold Voltage vs Temperature



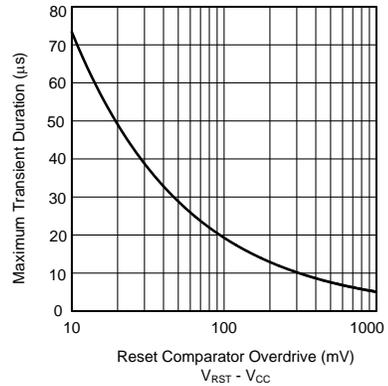
Reset Timeout Period vs V<sub>CC</sub>



Reset Timeout Period vs Temperature

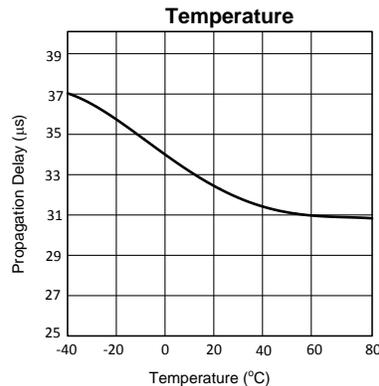


Max. Transient Duration vs Reset Comparator Overdrive (V<sub>CC</sub> = 3.3V)



## Typical Performance Characteristics (continued)

### Low-Line Comparator Propagation Delay vs



## Circuit Information

### RESET OUTPUT

The Reset input of a  $\mu\text{P}$  initializes the device into a known state. The LM3704/LM3705 microprocessor supervisory circuits assert a forced reset output to prevent code execution errors during power-up, power-down, and brownout conditions.

$\overline{\text{RESET}}$  is guaranteed valid for  $V_{\text{CC}} > 1\text{V}$ . Once  $V_{\text{CC}}$  exceeds the reset threshold, an internal timer maintains the output for the reset timeout period. After this interval, reset goes high. The LM3704 offers an active-low  $\overline{\text{RESET}}$ ; The LM3705 offers an active-high  $\overline{\text{RESET}}$ .

Any time  $V_{\text{CC}}$  drops below the reset threshold (such as during a brownout), the reset activates. When  $V_{\text{CC}}$  again rises above the reset threshold, the internal timer starts. Reset holds until  $V_{\text{CC}}$  exceeds the reset threshold for longer than the reset timeout period. After this time, reset releases.

The Manual Reset input ( $\overline{\text{MR}}$ ) will initiate a forced reset also. See the *Manual Reset Input* section.

### RESET THRESHOLD

The LM3704/LM3705 family is available with a reset voltage of 3.08V. Other reset thresholds in the 2.20V to 5.0V range, in steps of 10 mV, are available; contact National Semiconductor for details.

### MANUAL RESET INPUT ( $\overline{\text{MR}}$ )

Many  $\mu\text{P}$ -based products require a manual reset capability, allowing the operator to initiate a reset. The  $\overline{\text{MR}}$  input is fully debounced and provides an internal 56 k $\Omega$  pull-up. When the  $\overline{\text{MR}}$  input is pulled below  $V_{\text{MRT}}$  (1.225V) for more than 25  $\mu\text{s}$ , reset is asserted after a typical delay of 12  $\mu\text{s}$ . Reset remains active as long as  $\overline{\text{MR}}$  is held low, and releases after the reset timeout period expires after  $\overline{\text{MR}}$  rises above  $V_{\text{MRT}}$ . Use  $\overline{\text{MR}}$  with digital logic to assert or to daisy chain supervisory circuits. It may be used as another low-line comparator by adding a buffer.

### POWER-FAIL COMPARATOR ( $\overline{\text{PFI/PFO}}$ )

The PFI is compared to a 1.225V internal reference,  $V_{\text{PFT}}$ . If PFI is less than  $V_{\text{PFT}}$ , the Power Fail Output  $\overline{\text{PFO}}$  drops low. The power-fail comparator signals a falling power supply, and is driven typically by an external voltage divider that senses either the unregulated supply or another system supply voltage. The voltage divider generally is chosen so the voltage at PFI drops below  $V_{\text{PFT}}$  several milliseconds before the main supply voltage drops below the reset threshold, providing advanced warning of a brownout.

The voltage threshold is set by  $R_1$  and  $R_2$  and is calculated as follows:

$$V_{\text{PFT}} = \left( \frac{R_1 + R_2}{R_2} \right) \times 1.225\text{V} \quad (1)$$

Note this comparator is completely separate from the rest of the circuitry, and may be employed for other functions as needed.

## LOW-LINE OUTPUT ( $\overline{\text{LLO}}$ )

The low-line output comparator is typically used to provide a non-maskable interrupt to a  $\mu\text{P}$  when  $V_{\text{CC}}$  begins falling.  $\overline{\text{LLO}}$  monitors  $V_{\text{CC}}$  and goes low when  $V_{\text{CC}}$  falls below  $V_{\text{LLOT}}$  (typically  $1.02 \cdot V_{\text{RST}}$ ) with hysteresis of  $0.0032 \cdot V_{\text{RST}}$ .

## SPECIAL PRECAUTIONS FOR THE MICRO SMD PACKAGE

As with most integrated circuits, the LM3704 and LM3705 are sensitive to exposure from visible and infrared (IR) light radiation. Unlike a plastic encapsulated IC, the micro SMD package has very limited shielding from light, and some sensitivity to light reflected from the surface of the PC board or long wavelength IR entering the die from the side may be experienced. This light could have an unpredictable affect on the electrical performance of the IC. Care should be taken to shield the device from direct exposure to bright visible or IR light during operation.

## MICRO SMD MOUNTING

The micro SMD package requires specific mounting techniques which are detailed in National Semiconductor Application Note AN-1112. Referring to the section **Surface Mount Technology (SMT) Assembly Considerations**, it should be noted that the pad style which must be used with the 9-pin package is the NSMD (non-solder mask defined) type.

For best results during assembly, alignment ordinals on the PC board may be used to facilitate placement of the micro SMD device.

TEST CIRCUIT DIAGRAMS

Timing Diagrams

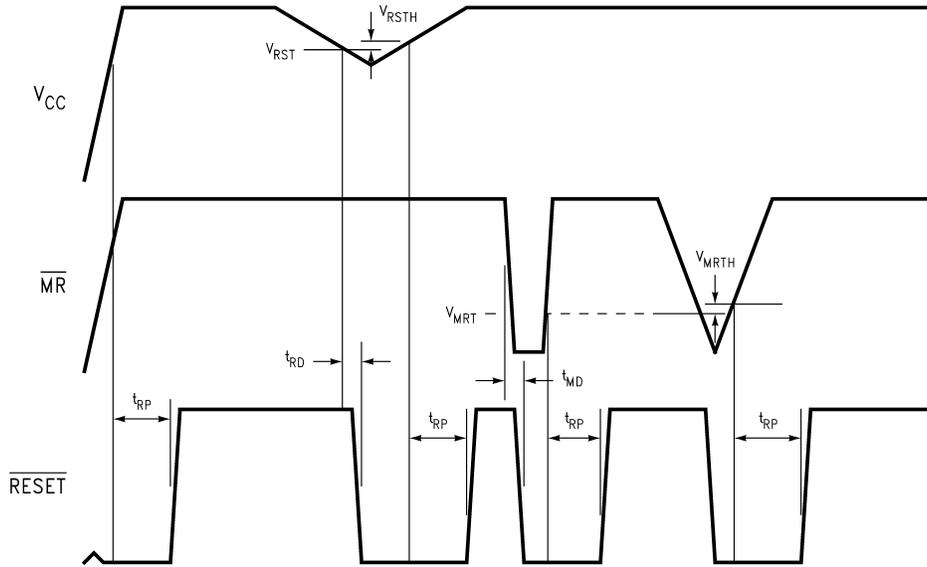


Figure 4. LM3704 Reset Time with MR

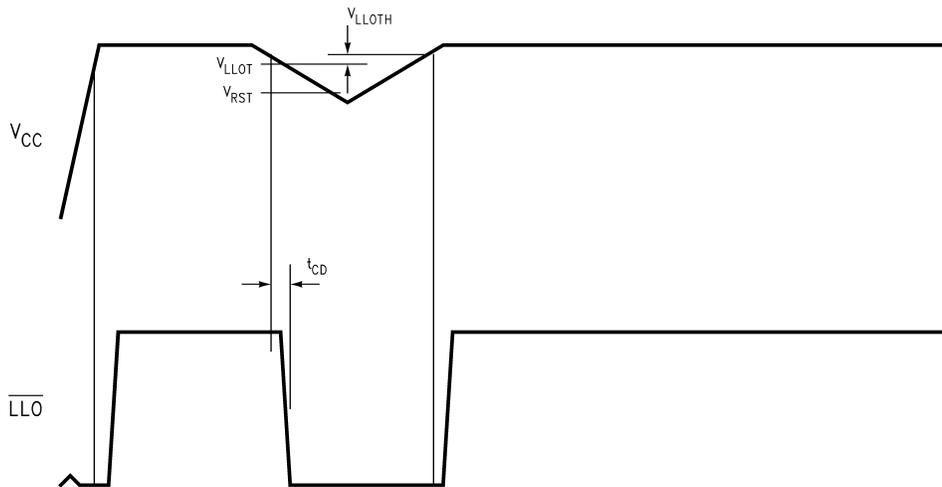


Figure 5. LLO Output

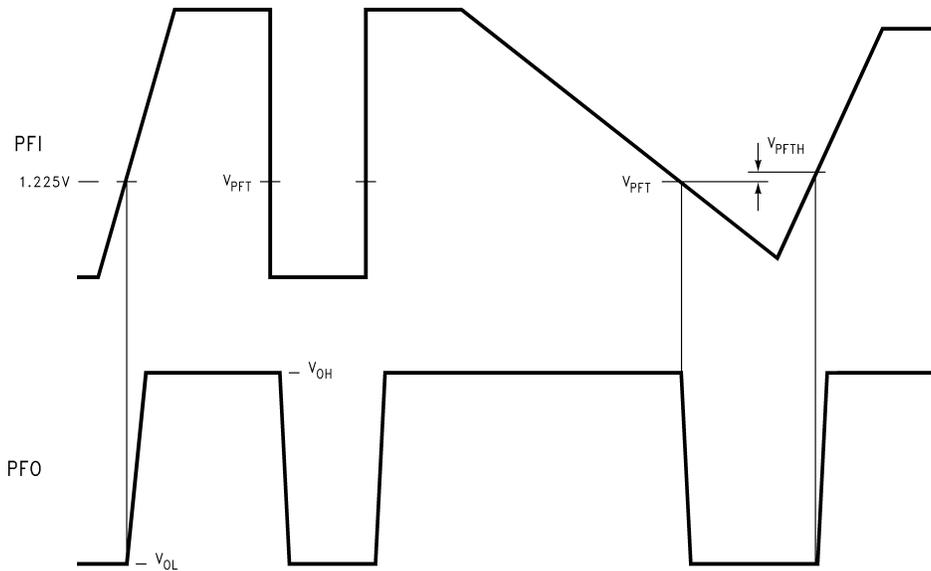


Figure 6. PFI Comparator Timing Diagram

Typical Application Circuits

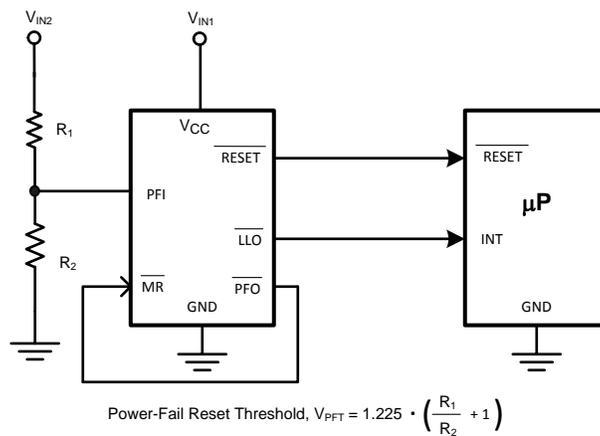


Figure 7. Monitoring Two Critical Supplies

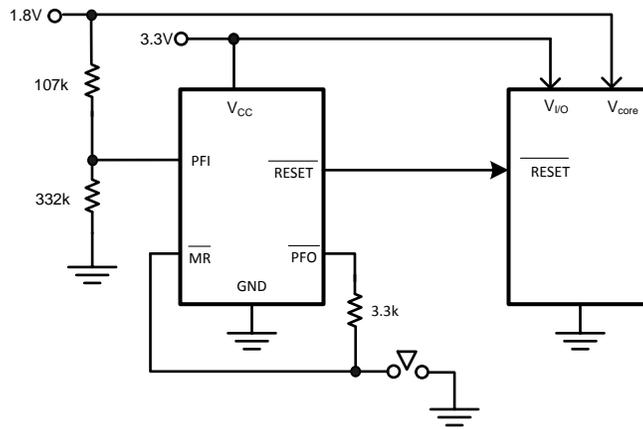


Figure 8. Monitoring Two Supplies plus Manual Reset

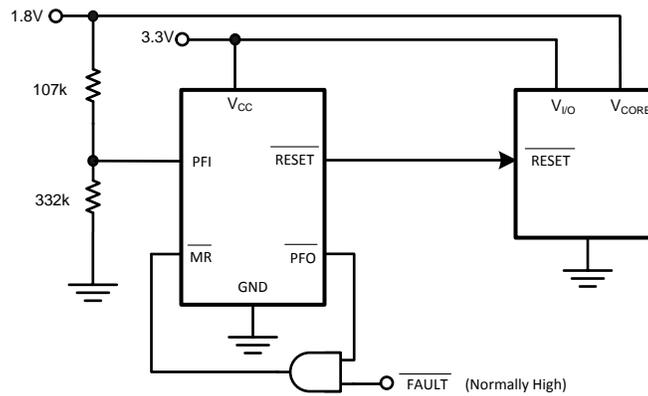


Figure 9. Monitoring Dual Supplies plus External Fault Input

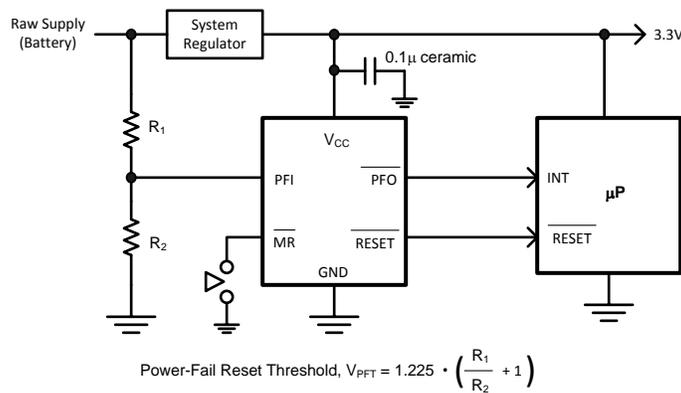


Figure 10. Microprocessor Supervisor with Early Warning Detector

Note:  $\overline{MR}$  input with its 1.225V nominal threshold, may monitor an additional supply voltage. An internal 56 kΩ pull-up resistor is included on this input.

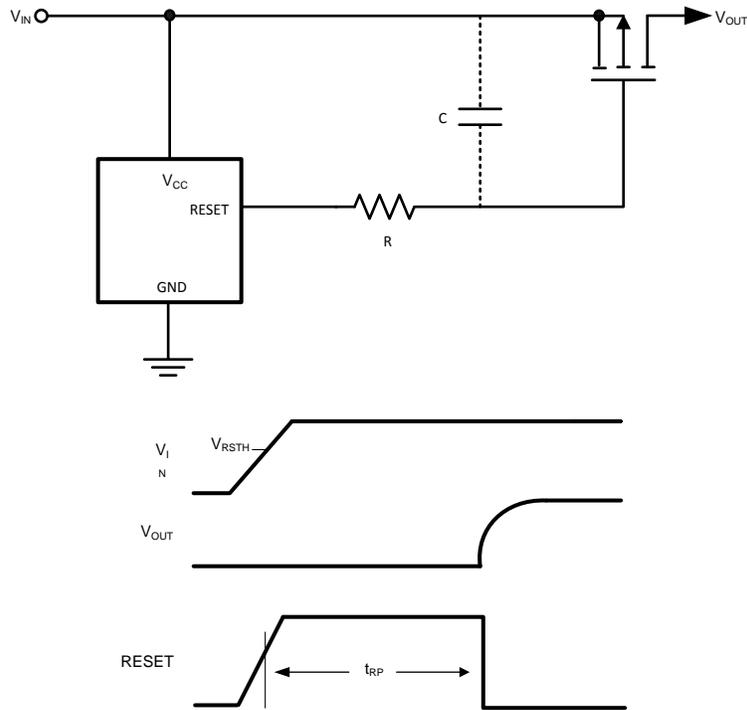


Figure 11. LM3705 Power-On Delay

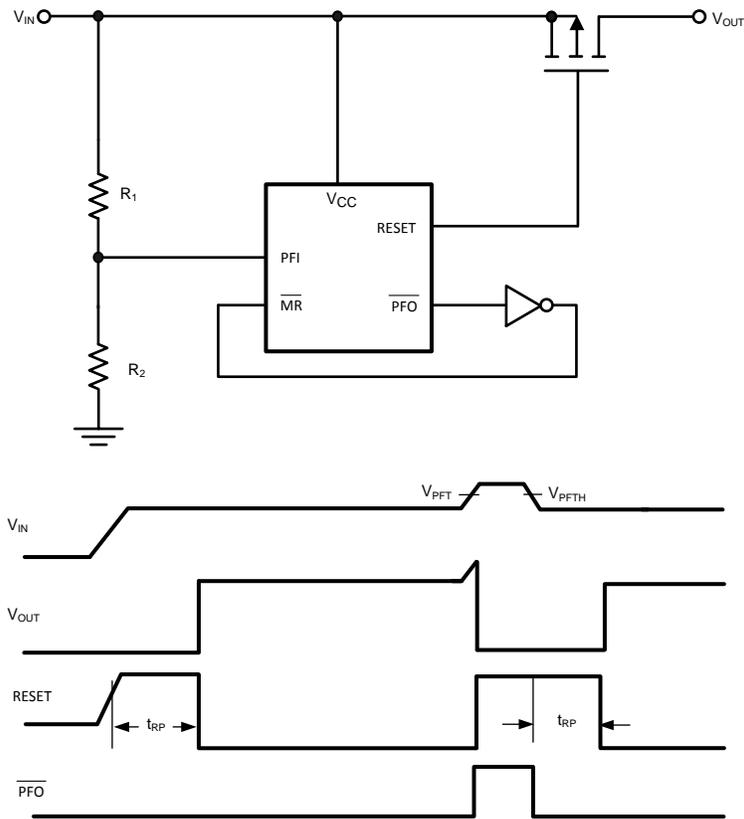


Figure 12. LM3705 Power-On Delay with Overvoltage Protection

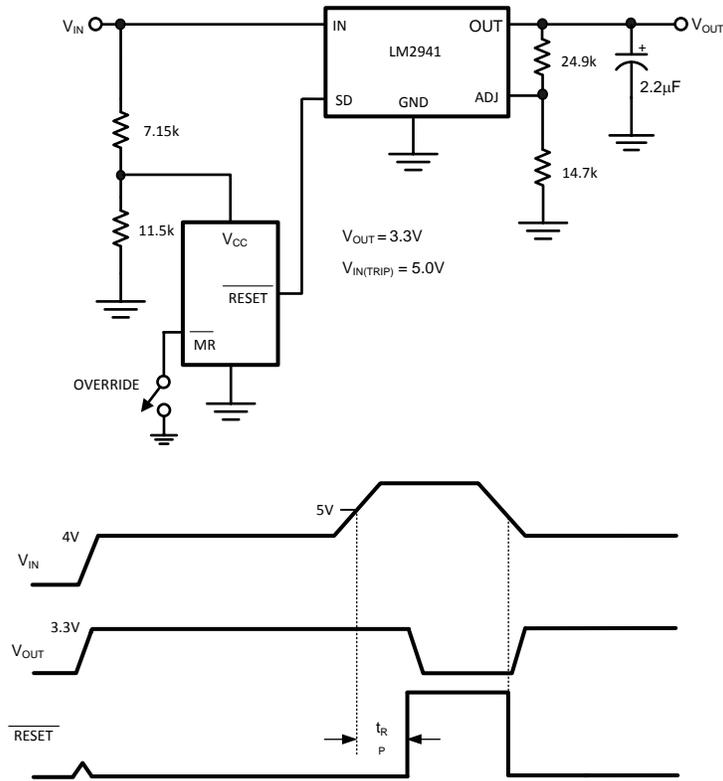


Figure 13. Regulator/Switch with Long-Term Overvoltage Lockout Prevents Overdissipation in Linear Regulator

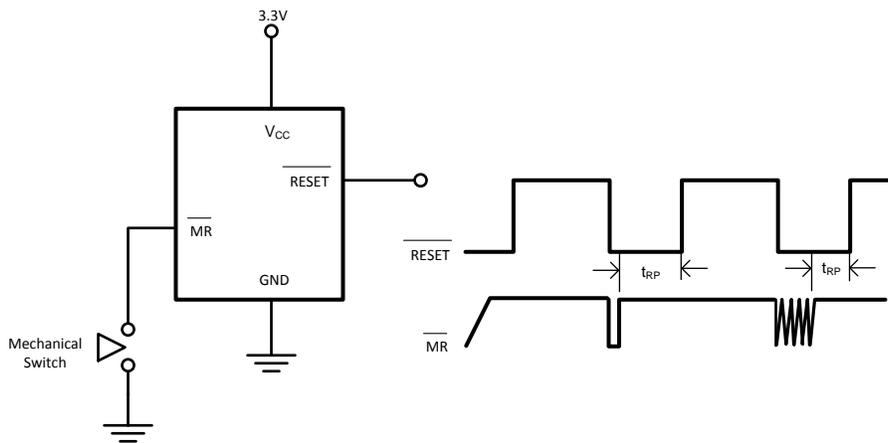


Figure 14. Switch Debouncer

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LM3704XCMM-308/NOPB	ACTIVE	VSSOP	DGS	10	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	R35B	
LM3704YBMM-360	ACTIVE	VSSOP	DGS	10	1000	TBD	Call TI	Call TI		R49B	
LM3704YBMM-360/NOPB	ACTIVE	VSSOP	DGS	10	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM		R49B	
LM3704YCMM-232/NOPB	ACTIVE	VSSOP	DGS	10	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM		R76B	
LM3704YCMM-308/NOPB	ACTIVE	VSSOP	DGS	10	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	R48B	
LM3704YCMMX-308/NOPB	ACTIVE	VSSOP	DGS	10	3500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	R48B	

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

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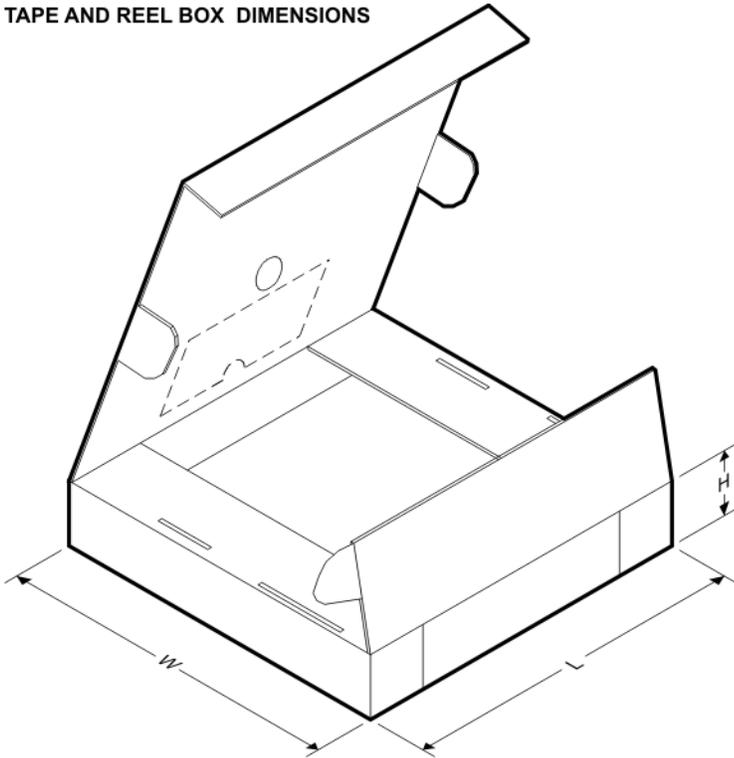
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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM3704XCMM-308/NOPB	VSSOP	DGS	10	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM3704YBMM-360	VSSOP	DGS	10	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM3704YBMM-360/NOPB	VSSOP	DGS	10	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM3704YCMM-232/NOPB	VSSOP	DGS	10	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM3704YCMM-308/NOPB	VSSOP	DGS	10	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM3704YCMXB-308/NOPB	VSSOP	DGS	10	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1

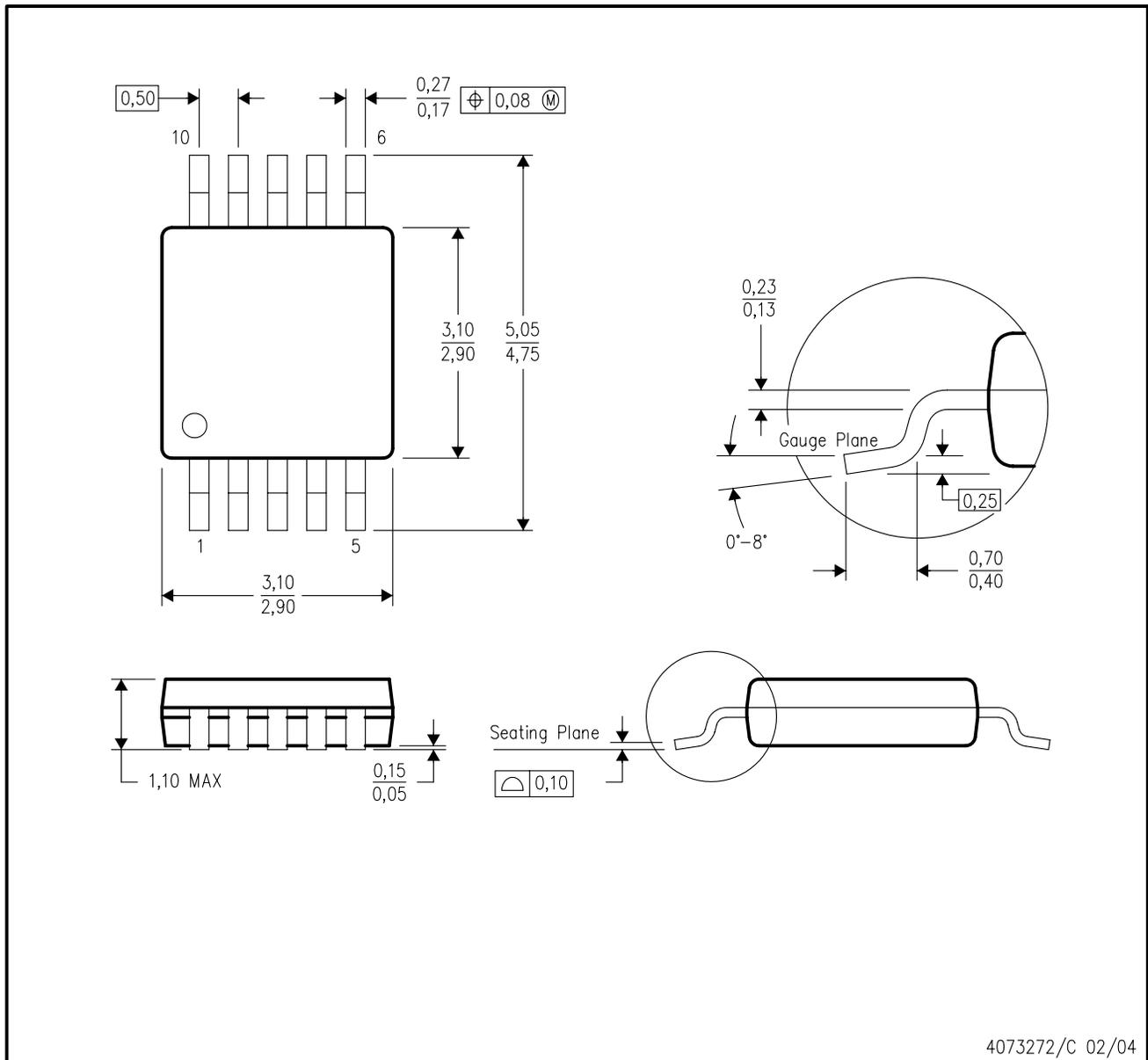
**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM3704XCMM-308/NOPB	VSSOP	DGS	10	1000	203.0	190.0	41.0
LM3704YBMM-360	VSSOP	DGS	10	1000	203.0	190.0	41.0
LM3704YBMM-360/NOPB	VSSOP	DGS	10	1000	203.0	190.0	41.0
LM3704YCMM-232/NOPB	VSSOP	DGS	10	1000	203.0	190.0	41.0
LM3704YCMM-308/NOPB	VSSOP	DGS	10	1000	203.0	190.0	41.0
LM3704YCMMX-308/NOP B	VSSOP	DGS	10	3500	349.0	337.0	45.0

DGS (S-PDSO-G10)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion.
  - D. Falls within JEDEC MO-187 variation BA.

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